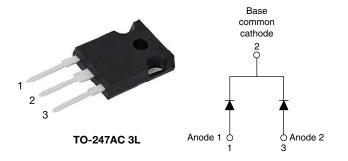


Ultrafast Rectifier, FRED Pt®, 2 x 30 A



| PRIMARY CHARACTERISTICS | | | | | | |
|----------------------------------|----------------|--|--|--|--|--|
| I _{F(AV)} | 2 x 30 A | | | | | |
| V_{R} | 600 V | | | | | |
| V _F at I _F | 1.1 V | | | | | |
| t _{rr} typ. | 27 ns | | | | | |
| T _J max. | 175 °C | | | | | |
| Package | TO-247AC 3L | | | | | |
| Circuit configuration | Common cathode | | | | | |

FEATURES

- Ultrafast recovery time
- Low forward voltage drop
- · Low leakage current
- 175 °C operating junction temperature
- Designed and qualified according to JEDEC®-JESD 47





ROHS COMPLIANT HALOGEN FREE

DESCRIPTION / APPLICATIONS

VS-60CPU06... series are the state of the art ultrafast recovery rectifiers designed with optimized performance of forward voltage drop and ultrafast recovery time.

The planar structure and the platinum doped life time control guarantee the best overall performance, ruggedness and reliability characteristics.

These devices are intended for use in the output rectification stage of SMPS, welding, UPS, DC/DC converters as well as freewheeling diodes in low voltage inverters and chopper motor drives.

Their extremely optimized stored charge and low recovery current minimize the switching losses and reduce over dissipation in the switching element and snubbers.

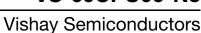
| ABSOLUTE MAXIMUM RATINGS | | | | | | | |
|---|------------|-----------------------------------|---|-------------|-------|--|--|
| PARAMETER | | SYMBOL | TEST CONDITIONS | VALUES | UNITS | | |
| Repetitive peak reverse voltage | | V_{RRM} | | 600 | V | | |
| Average rectified forward current | per leg | I _{F(AV)} | | 30 | | | |
| | per device | | Rated V _R , T _C = 137 °C | 60 | | | |
| Non-repetitive peak surge current per leg | | I _{FSM} | $T_J = 25$ °C, $t_p = 10$ ms | 300 | Α | | |
| Peak repetitive forward current per leg | | I _{FM} | Rated V _R , square wave, 20 kHz, T _C = 137 °C | 60 | | | |
| Operating junction and storage ten | nperatures | T _J , T _{Stg} | | -65 to +175 | °C | | |

| ELECTRICAL SPECIFICATIONS (T _J = 25 °C unless otherwise specified) | | | | | | | | |
|--|-------------------------------------|--|------|------|------|--------|--|--|
| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNITS | | |
| Breakdown voltage, blocking voltage | V _{BR} , V _R | Ι _R = 100 μΑ | 600 | - | - | | | |
| Forward voltage | V _F | I _F = 30 A | - | 1.31 | 1.65 | 1.65 V | | |
| | | I _F = 30 A, T _J = 150 °C | - | 1.1 | 1.4 | | | |
| Deverage legicage everyont | | $V_R = V_R$ rated | - | 0.02 | 50 | | | |
| Reverse leakage current | I _R | T _J = 150 °C, V _R = V _R rated | - | 30 | μA | | | |
| Junction capacitance | C _T | V _R = 200 V | | 22 | - | pF | | |
| Series inductance | L _S | Measured lead to lead 5 mm from package body | - | 3.5 | - | nH | | |



| DYNAMIC RECOVERY CHARACTERISTICS (T _J = 25 °C unless otherwise specified) | | | | | | | | |
|---|------------------|-------------------------------------|---|------|------|-------|-----|--|
| PARAMETER | SYMBOL | TEST CO | MIN. | TYP. | MAX. | UNITS | | |
| | | $I_F = 1.0 \text{ A}, dI_F/dt = 10$ | $I_F = 1.0 \text{ A}, dI_F/dt = 100 \text{ A/}\mu\text{s}, V_R = 30 \text{ V}$ | | 27 | 35 | | |
| Reverse recovery time | t _{rr} | T _J = 25 °C | | - | 42 | - | ns | |
| | | T _J = 125 °C | $I_F = 30 \text{ A}$ $dI_F/dt = -200 \text{ A/}\mu\text{s}$ $V_R = 200 \text{ V}$ | - | 110 | - | | |
| Peak recovery current | I _{RRM} | T _J = 25 °C | | - | 5 | = | А | |
| | | T _J = 125 °C | | - | 11 | = | | |
| Reverse recovery charge | Q _{rr} | T _J = 25 °C | | - | 110 | - | 200 | |
| | | T _J = 125 °C | | - | 630 | - | nC | |

| THERMAL - MECHANICAL SPECIFICATIONS (T _J = 25 °C unless otherwise noted) | | | | | | | |
|---|-----------------------------------|---|--------------|------|------------|------------------------|--|
| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNITS | |
| Maximum junction and storage temperature range | T _J , T _{Stg} | | -65 | - | 175 | °C | |
| Thermal resistance, junction to case per leg | R _{thJC} | | - | 0.6 | 0.9 | | |
| Thermal resistance, junction to ambient per leg | R _{thJA} | Typical socket mount | - | - | 70 | °C/W | |
| Thermal resistance, case to heatsink | R _{thCS} | Mounting surface, flat, smooth, and greased | - | 0.4 | - | | |
| Waiselat | | | - | 6.0 | - | g | |
| Weight | | | - | 0.22 | - | oz. | |
| Mounting torque | | | 6.0 (5.0) | - | 12 (10) | kgf · cm (lbf · in) | |
| Marking device | | Case style TO-247AC 3L | 60CPU06 | | | | |





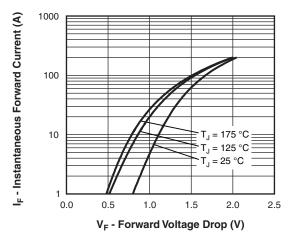


Fig. 1 - Typical Forward Voltage Drop Characteristics

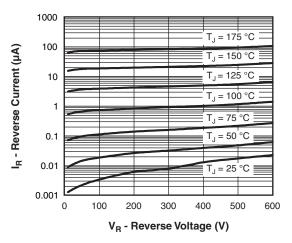


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

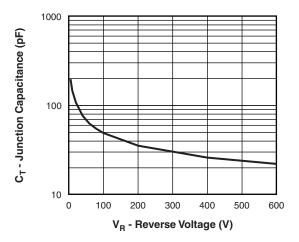


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

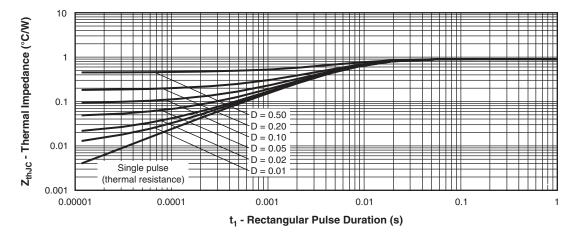


Fig. 4 - Maximum Thermal Impedance Z_{thJC} Characteristics



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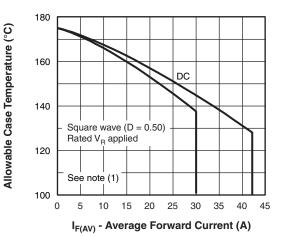


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current

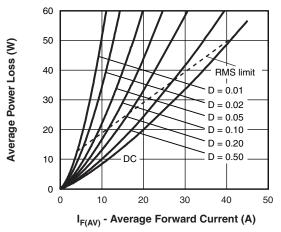
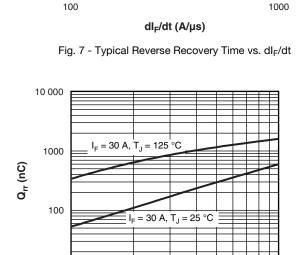


Fig. 6 - Forward Power Loss Characteristics



 $I_F = 30 \text{ A}, T_J = 125 \text{ }^{\circ}\text{C}$

 $I_F = 30 \text{ A}, T_J = 25 \text{ }^{\circ}\text{C}$

1000

100

10

10

100

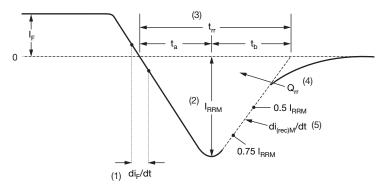
t_{rr} (ns)

 dI_F/dt (A/ μ s) Fig. 8 - Typical Stored Charge vs. dI_F/dt

1000

Note

 $\begin{array}{ll} \text{(1)} & \text{Formula used: } T_C = T_J - (Pd + Pd_{REV}) \ x \ R_{thJC}; \\ Pd = \text{forward power loss} = I_{F(AV)} \ x \ V_{FM} \ at \ (I_{F(AV)}/D) \ (\text{see fig. 6}); \\ Pd_{REV} = \text{inverse power loss} = V_{R1} \ x \ I_R \ (1 - D); \ I_R \ at \ V_{R1} = \text{rated } V_R \\ \end{array}$



- (1) di_F/dt rate of change of current through zero crossing
- (2) I_{RRM} peak reverse recovery current
- (3) $\rm t_{rr}$ reverse recovery time measured from zero crossing point of negative going $\rm l_{F}$ to point where a line passing through 0.75 $\rm l_{RRM}$ and 0.50 $\rm l_{RRM}$ extrapolated to zero current.
- (4) $\mathbf{Q}_{\rm rr}$ area under curve defined by $\mathbf{t}_{\rm rr}$ and $\mathbf{I}_{\rm RRM}$

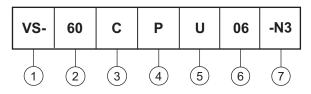
$$Q_{rr} = \frac{t_{rr} \times I_{RRM}}{2}$$

(5) di_{(rec)M}/dt - peak rate of change of current during t_b portion of t_{rr}

Fig. 9 - Reverse Recovery Waveform and Definitions

ORDERING INFORMATION TABLE

Device code



- 1 Vishay Semiconductors product
- 2 Current rating (60 = 60 A)
- 3 Circuit configuration:

C = common cathode

4 - Package:

P = TO-247AC (modified)

5 - U = ultrafast rectifier

6 - Voltage rating (06 = 600 V)

7 - Environmental digit:

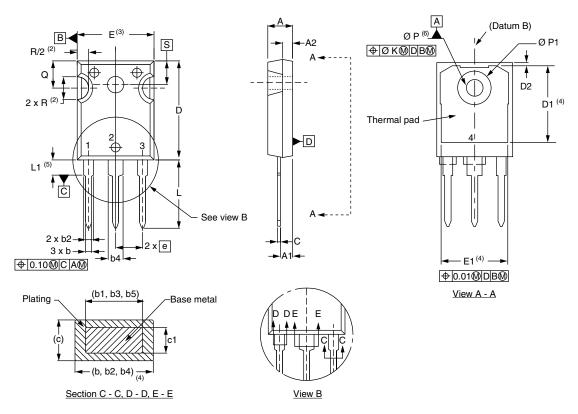
-N3 = halogen-free, RoHS-compliant, and totally lead (Pb)-free

| ORDERING INFORMATION (Example) | | | | | | | |
|--------------------------------|------------------|------------------------|-------------------------|--|--|--|--|
| PREFERRED P/N | QUANTITY PER T/R | MINIMUM ORDER QUANTITY | PACKAGING DESCRIPTION | | | | |
| VS-60CPU06-N3 | 25 | 500 | Antistatic plastic tube | | | | |

| LINKS TO RELATED DOCUMENTS | | | | | |
|----------------------------|--------------------------|--|--|--|--|
| Dimensions | www.vishay.com/doc?96138 | | | | |
| Part marking information | www.vishay.com/doc?95007 | | | | |
| SPICE model | www.vishay.com/doc?96084 | | | | |

TO-247AC 3L

DIMENSIONS in millimeters and inches



| SYMBOL | MILLIN | IETERS | INCHES | | NOTES | |
|---------|--------|--------|--------|-------|-------|--|
| STWIBOL | MIN. | MAX. | MIN. | MAX. | NOTES | |
| Α | 4.65 | 5.31 | 0.183 | 0.209 | | |
| A1 | 2.21 | 2.59 | 0.087 | 0.102 | | |
| A2 | 1.17 | 1.37 | 0.046 | 0.054 | | |
| b | 0.99 | 1.40 | 0.039 | 0.055 | | |
| b1 | 0.99 | 1.35 | 0.039 | 0.053 | | |
| b2 | 1.65 | 2.39 | 0.065 | 0.094 | | |
| b3 | 1.65 | 2.34 | 0.065 | 0.092 | | |
| b4 | 2.59 | 3.43 | 0.102 | 0.135 | | |
| b5 | 2.59 | 3.38 | 0.102 | 0.133 | | |
| С | 0.38 | 0.89 | 0.015 | 0.035 | | |
| c1 | 0.38 | 0.84 | 0.015 | 0.033 | | |
| D | 19.71 | 20.70 | 0.776 | 0.815 | 3 | |
| D1 | 13.08 | - | 0.515 | - | 4 | |

| SYMBOL | MILLIMETERS | | INC | INCHES | | |
|--------|-------------|----------|-------|--------|-------|--|
| STMBOL | MIN. | MAX. | MIN. | MAX. | NOTES | |
| D2 | 0.51 | 1.35 | 0.020 | 0.053 | | |
| E | 15.29 | 15.87 | 0.602 | 0.625 | 3 | |
| E1 | 13.46 | - | 0.53 | 1 | | |
| е | 5.46 BSC | | 0.215 | BSC | | |
| ØK | 0.2 | 254 | 0.010 | | | |
| L | 14.20 | 16.10 | 0.559 | 0.634 | | |
| L1 | 3.71 | 4.29 | 0.146 | 0.169 | | |
| ØΡ | 3.56 | 3.66 | 0.14 | 0.144 | | |
| Ø P1 | - | 7.39 | - | 0.291 | | |
| Q | 5.31 | 5.69 | 0.209 | 0.224 | | |
| R | 4.52 | 5.49 | 0.178 | 0.216 | | |
| S | 5.51 | 5.51 BSC | | BSC | | |
| | | | | | | |

Notes

- (1) Dimensioning and tolerancing per ASME Y14.5M-1994
- (2) Contour of slot optional
- (3) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- (4) Thermal pad contour optional with dimensions D1 and E1
- (5) Lead finish uncontrolled in L1
- (6) Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")
- (7) Outline conforms to JEDEC® outline TO-247 with exception of dimension Q



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Vishay

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